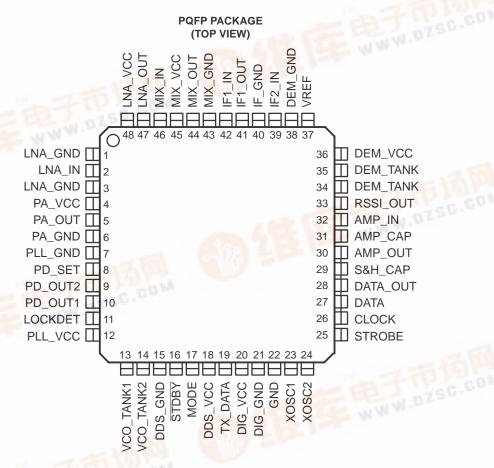
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- Single-Chip RF Transceiver for 868 MHz and 915 MHz ISM Bands
- 850 MHz to 950 MHz Operation
- FM/FSK Operation for Transmit and Receive
- 24-Bit Direct Digital Synthesizer (DDS) With 11-Bit DAC
- On-Chip VCO and PLL
- On-Chip Reference Oscillator
- Minimal External Components Required
- Low Power Consumption

- Typical Output Power of 4.5 dBm
- Typical Output Frequency Resolution of 230 Hz
- Ultrafast Lock Times From DDS Implementation
- Two Fully Programmable Operational
   Modes
- 2.2 V to 3.6 V Operation
- Fast Radio Strength Signal Indicator (RSSI)
- Flexible Serial Interface to TI MSP430 Microcontroller
- 48-Pin Low Profile Plastic Quad Flat Package (PQFP)





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



## TRF6900 SINGLE-CHIP RF TRANSCEIVER

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## description

The TRF6900 single-chip solution is an integrated circuit intended for use as a low cost FSK transceiver to establish a frequency-agile, half-duplex, bidirectional RF link. The device is available in a 48-lead TQFP package and is designed to provide a fully-functional multichannel FM transceiver. The chip is intended for linear (FM) or digital (FSK) modulated applications in the new 868 MHz European band and the North American 915 MHz ISM band. The single chip transceiver operates down to 2.2 V and is expressly designed for low power consumption. The synthesizer has a typical channel spacing of approximately 230 Hz to allow narrow-band as well as wide-band application. Due to the narrow channel spacing of the direct digital synthesizer (DDS), the DDS can be used to adjust the TX/RX frequency and allows the use of inexpensive reference crystals.

Two fully-programmable operation modes, Mode0 and Mode1, allow extremely fast switching between two preprogrammed settings (e.g., receive(RX)/transmit(TX); TX\_frequency\_0/TX\_frequency\_1; RX\_frequency\_0/RX\_frequency\_1;...) without reprogramming the device. Each functional block of the transceiver can be specifically enabled or disabled via the serial interface.

#### ISM band standards

Europe has assigned a new unlicensed frequency band of 868 MHz to 870 MHz. This new band is specifically defined for short range devices with duty cycles from 0.1% to 100% in several sub-bands. The existing 433 MHz band for short-range devices in Europe has the great disadvantage of very high usage. The new European frequency band, due to the duty cycle assignment, allows a reliable RF link and makes many new applications possible.

The North American unlicensed ISM (industrial, scientific, and medical) band covers 902 MHz to 928 MHz (center frequency of 915 MHz), and is suitable for short range RF links.

#### transmitter

The transmitter consists of an integrated VCO, a complete fully-programmable direct digital synthesizer, and a power amplifier. The internal VCO can be used with an external tank circuit or an external VCO. The divider, prescaler, and reference oscillator require only the addition of an external crystal and a loop filter to provide a complete DDS with a typical frequency resolution of 230 Hz.

The 8-bit FSK frequency deviation register determines the frequency deviation in FSK mode. The modulation itself is done in the direct digital synthesizer, hence no additional external components are necessary.

Since the typical RF output power is approximately 4.5 dBm, no additional external RF power amplifier is necessary in most applications.

#### receiver

The integrated receiver is intended to be used as a single-conversion FSK receiver. It consists of a low noise amplifier, mixer, IF amplifier, limiter, FM/FSK demodulator with an external LC tank circuit, and a data slicer. The receive strength signal indicator (RSSI) can be used for fast carrier sense detection or as an on/off keying, or amplitude shift keying, (OOK/ASK) demodulator. In the *learning mode*, during a learning sequence (0,1,0,1,0,....), the initial tolerances of the LC demodulator tank circuit are compensated and an external capacitor is charged to a dc voltage that is proportional to the average demodulation dc level. This level is the zero reference for the data slicer to generate the logical levels of the data sequence that follow the learning sequence. Using the internal data switch, the demodulated OOK and FSK signals are available at the same DATA\_OUT terminal.

#### baseband interface

The TRF6900 can easily be interfaced to a baseband processor such as the Texas Instruments MSP430 ultra low-power microcontroller (see Figure 1). The TRF6900 serial control registers are programmed by the MSP430 and the MSP430 performs baseband operations in software.



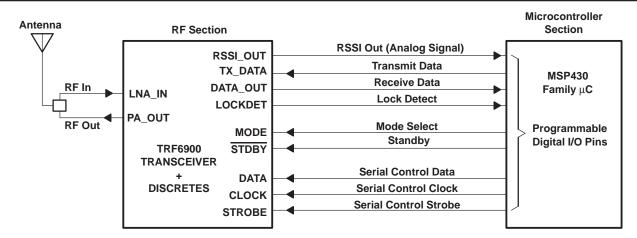
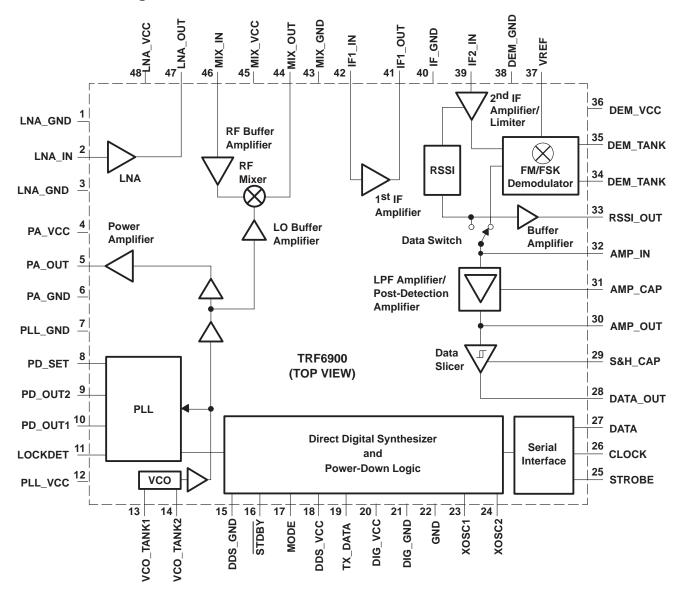


Figure 1. System Block Diagram for Interfacing to the MSP430 Microcontroller

## functional block diagram



### **Terminal Functions**

| TERMIN   | IAL | 1/0 | DESCRIPTION  |
|----------|-----|-----|--|
| NAME     | NO. | 1/0 | DESCRIPTION  |
| AMP_CAP  | 31  | I/O | Connection for LPF amplifier/post-detection amplifier capacitor/resistor used to reduce the internal low pass filter frequency and to adjust the post-detection gain |
| AMP_IN   | 32  | I   | Analog post-detection amplifier input  |
| AMP_OUT  | 30  | 0   | Analog post-detection amplifier output   |
| CLOCK    | 26  | I   | Serial interface clock signal  |
| DATA     | 27  | I   | Serial interface data signal   |
| DATA_OUT | 28  | 0   | Digital output of the data slicer, active high   |
| DDS_GND  | 15  |     | Direct digital synthesizer ground  |



# **Terminal Functions (Continued)**

| TERMIN    | AL     | 1/0 | DESCRIPTION   |
|-----------|--------|-----|---|
| NAME      | NO.    | 1/0 | DESCRIPTION   |
| DDS_VCC   | 18     |     | Direct digital synthesizer supply voltage   |
| DEM_GND   | 38     |     | Quadrature demodulator ground   |
| DEM_TANK  | 34, 35 | I/O | Quadrature demodulator tank connection  |
| DEM_VCC   | 36     |     | Quadrature demodulator supply voltage   |
| DIG_GND   | 21     |     | Digital ground  |
| DIG_VCC   | 20     |     | Digital supply voltage  |
| IF_GND    | 40     |     | Intermediate frequency (IF) section ground  |
| IF1_IN    | 42     |     | Single-ended input for the 1 <sup>St</sup> intermediate frequency (IF) amplifier  |
| IF1_OUT   | 41     | 0   | Single-ended output for the 1 <sup>St</sup> intermediate frequency (IF) amplifier   |
| IF2_IN    | 39     | ı   | Single-ended input for the 2 <sup>nd</sup> IF amplifier/limiter   |
| LNA_GND   | 1, 3   |     | Low-noise amplifier ground  |
| LNA_IN    | 2      | ı   | Low-noise amplifier input   |
| LNA_OUT   | 47     | 0   | Low-noise amplifier output, open collector  |
| LNA_VCC   | 48     |     | Low-noise amplifier supply voltage  |
| LOCKDET   | 11     | 0   | PLL lock detect output, active high. PLL locked when LOCKDET=1.   |
| MIX_GND   | 43     |     | Mixer ground  |
| MIX_IN    | 46     | ı   | Single-ended RF mixer input   |
| MIX_OUT   | 44     | 0   | Single-ended RF mixer output  |
| MIX_VCC   | 45     |     | Mixer supply voltage  |
| MODE      | 17     | I   | Mode select input. The functionality of the device in Mode0 or Mode1 can be programmed via the A-, B-, C-, and D-word of the serial control interface.                    |
| GND       | 22     |     | Ground  |
| PA_GND    | 6      |     | Power amplifier ground  |
| PA_OUT    | 5      | 0   | Power amplifier output, open collector  |
| PA_VCC    | 4      |     | Power amplifier supply voltage  |
| PD_OUT1   | 10     | 0   | Charge pump output – PLL in locked condition  |
| PD_OUT2   | 9      | 0   | Charge pump output – PLL in unlocked condition  |
| PD_SET    | 8      |     | Charge pump current setting terminal. An external resistor, R <sub>PD</sub> , is connected to this terminal to set the nominal charge pump current.                       |
| PLL_GND   | 7      |     | PLL ground  |
| PLL_VCC   | 12     |     | PLL supply voltage  |
| RSSI_OUT  | 33     | 0   | Receive strength signal indicator, analog output  |
| S&H_CAP   | 29     | I/O | Connection for sample and hold capacitor for the data slicer. This capacitor determines the integration time constant of the integrator while in the learning mode.       |
| STDBY     | 16     | ı   | Standby control for the TRF6900, active low. While STDBY=0, the contents of the control registers are still valid and can be programmed via the serial control interface. |
| STROBE    | 25     | ı   | Serial interface strobe signal  |
| TX_DATA   | 19     | ı   | Digital modulation input for FSK/FM modulation of the carrier, active high  |
| VCO_TANK1 | 13     | ı   | VCO tank circuit connection. Should be left open if an external VCO is used.  |
| VCO_TANK2 | 14     | ı   | VCO tank circuit connection. May also be used to input an external VCO signal.  |
| VREF      | 37     | ı   | Reference voltage for the quadrature demodulator  |
| XOSC1     | 23     | 0   | Reference crystal oscillator connection   |
| XOSC2     | 24     | ı   | Reference crystal oscillator connection. May be used as a single-ended clock input if an external crystal is not used.  |



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## absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

## recommended operating conditions

|  | MIN                  | TYP MAX | UNIT |
|--|----------------------|---------|------|
| Supply voltage, PA_VCC, PLL_VCC, DIG_VCC, DDS_VCC, DEM_VCC, MIX_VCC, LNA_VCC         | 2.2                  | 3.6     | V    |
| Operating temperature  | -20                  | 60      | °C   |
| High-level input voltage, VIH (DATA, CLOCK, STROBE, TX_DATA, MODE, STDBY)            | V <sub>CC</sub> -0.5 |         | V    |
| Low-level input voltage, V <sub>IL</sub> (DATA, CLOCK, STROBE, TX_DATA, MODE, STDBY) |                      | 0.5     | V    |

electrical characteristics over full range of operating conditions, (typical values are at PA\_VCC, PLL\_VCC, DDS\_VCC, DIG\_VCC, DEM\_VCC, MIX\_VCC, LNA\_VCC = 3 V,  $T_A$  = 25°C) (unless otherwise noted)

#### supply current consumption in each mode

|      | MODE                          | ACTIVE STAGES   | MIN | TYP | MAX | UNIT |
|------|-------------------------------|---|-----|-----|-----|------|
| Powe | er down (standby mode)        | None  |     | 2   | 5   | μΑ   |
|      | FSK (narrow-band) or er sense | DDS, PLL, VCO, LNA (normal mode), mixer, 1 <sup>St</sup> IF amplifier, limiter, (demodulator, LPF amplifier, data slicer or RSSI) |     | 24  | 31  | mA   |
|      | PA STATE                      |   |     |     |     |      |
|      | 0 dB attenuation              |   |     | 37  | 50  |      |
| TX   | 10 dB attenuation             | DDS, PLL, VCO, PA   |     | 26  | 33  | mA   |
|      | 20 dB attenuation             |   |     | 21  | 25  |      |
|      | PA disabled                   |   |     | 9.5 | 12  |      |



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All GND and VCC terminals must be connected to either ground or supply, respectively, even if the function block is not used.

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electrical characteristics over full range of operating conditions, (typical values are at PA\_VCC, PLL\_VCC, DDS\_VCC, DIG\_VCC, DEM\_VCC, MIX\_VCC, LNA\_VCC = 3 V,  $T_A$  = 25°C) (unless otherwise noted) (continued)

## LNA/RF mixer

| PARAMETER   | TEST CONDITIONS                       | MIN          | TYP        | MAX  | UNIT |
|---|---------------------------------------|--------------|------------|------|------|
| RF frequency range  |                                       | 850          |            | 950  | MHz  |
| I NIA goin  | LNA in normal mode                    | 9            | 13         |      | dB   |
| LINA gain   | LNA in low-gain mode                  |              | 2          |      | dB   |
| LNA noise figure  | LNA in normal mode                    |              | 3.3        | 5.5  | dB   |
| I NA input 1 dB compression   | LNA in normal mode                    | -20          | -15        |      | dBm  |
| RF frequency range  LNA gain  LNA noise figure  LNA input 1-dB compression  LNA input IP3  LNA input impedance  LNA output impedance  LO frequency range  F frequency range  Mixer conversion gain  Mixer SSB noise figure  Mixer input impedance  Mixer input IP3  Mixer input 1-dB compression  LO level at mixer Input | LNA in low-gain mode                  | -18          | -13        |      | dBm  |
| LNA input ID2   | LNA in normal mode                    | -12          | <b>-</b> 5 |      | dBm  |
| LINA INPULIES   | LNA in low-gain mode                  | -6           | 1          |      | dBm  |
| LNA input impedance   |                                       | See Figure 3 |            |      | Ω    |
| LNA output impedance  |                                       | See Figure 4 |            |      | Ω    |
| LO frequency range  |                                       | 850          |            | 950  | MHz  |
| IF frequency range  |                                       | 10           |            | 21.4 | MHz  |
| Mixer conversion gain   |                                       | -1           | 4.5        |      | dB   |
| Mixer SSB noise figure  | IF frequency = 10.7 MHz               |              | 26         |      | dB   |
| Mixer input impedance   |                                       | Se           | e Figure   | 5    | Ω    |
| Mixer input IP3   |                                       | -7           | 1          |      | dBm  |
| Mixer input 1-dB compression  |                                       | -14          | -9         |      | dBm  |
| LO level at mixer Input   |                                       |              |            | -30  | dBm  |
| Mixer output impedance  | IF frequency = 10.7 MHz, See Figure 6 |              | 330        |      | Ω    |

## **VCO**

| PARAMETER       | TEST CONDITIONS | MIN | TYP | MAX | UNIT   |
|-----------------|-----------------|-----|-----|-----|--------|
| Frequency range |                 | 850 |     | 950 | MHz    |
| Tuning range    |                 |     | 30  |     | MHz    |
| Phase noise     | 50 kHz offset   |     | -86 |     | dBc/Hz |
| Tuning voltage  |                 | 0.5 |     | 2.2 | V      |



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electrical characteristics over full range of operating conditions, (typical values are at PA\_VCC, PLL\_VCC, DDS\_VCC, DIG\_VCC, DEM\_VCC, MIX\_VCC, LNA\_VCC = 3 V,  $T_A$  = 25°C) (unless otherwise noted) (continued)

## 1st IF amplifier

| PARAMETER                           | TEST CONDITIONS                       | MIN  | TYP | MAX  | UNIT |
|-------------------------------------|---------------------------------------|------|-----|------|------|
| IF amplifier frequency range        |                                       | 10   |     | 21.4 | MHz  |
| IF amplifier gain                   |                                       | 5.5  | 7   |      | dB   |
| IF amplifier noise figure           |                                       |      | 11  | 13   | dB   |
| IF amplifier input 1-dB compression |                                       | -12  | -3  |      | dBm  |
| IF amplifier input IP3              |                                       | -3.5 | 4   |      | dBm  |
| IF amplifier input impedance        | IF frequency = 10.7 MHz, See Figure 8 |      | 330 |      | Ω    |
| IF amplifier output impedance       | IF frequency = 10.7 MHz, See Figure 9 |      | 330 |      | Ω    |

## 2<sup>nd</sup> IF amplifier/limiter

| PARAMETER                            | TEST CONDITIONS                        | MIN | TYP | MAX  | UNIT |
|--------------------------------------|--|-----|-----|------|------|
| IF amplifier/limiter frequency range |  | 10  |     | 21.4 | MHz  |
| IF amplifier/limiter gain            |  |     | 80  |      | dB   |
| IF amplifier/limiter noise figure    |  |     | 9   |      | dB   |
| IF amplifier/limiter input impedance | IF frequency = 10.7 MHz, See Figure 10 |     | 330 |      | Ω    |

### **RSSI**

| PARAMETER   | TEST CONDITIONS | MIN  | TYP | MAX | UNIT  |
|---|-----------------|------|-----|-----|-------|
| RSSI range at limiter input                                   |                 | -80  |     | -10 | dBm   |
| RSSI output voltage range                                     |                 | 0.44 |     | 2.6 | V     |
| Nominal slope   |                 |      | 19  |     | mV/dB |
| Response time step from power off to -20 dBm at limiter input |                 |      | 1   | 5   | μs    |

## low pass filter amplifier [2<sup>nd</sup> order]

| PARAMETER                          | TEST CONDITIONS | MIN | TYP  | MAX | UNIT |
|------------------------------------|-----------------|-----|------|-----|------|
| Internal low pass filter frequency |                 |     | 0.75 |     | MHz  |

## demodulator

| PARAMETER                     | TEST CONDITIONS         | MIN | TYP | MAX | UNIT |
|-------------------------------|-------------------------|-----|-----|-----|------|
| Demodulation output bandwidth | IF frequency = 10.7 MHz |     | 0.3 |     | MHz  |
| Acquisition range             | IF frequency = 10.7 MHz |     | 300 |     | kHz  |
| Slew rate†                    |                         |     | 2   |     | V/μs |

<sup>†</sup> Dependent upon external LC tank circuit.

#### data slicer

| PARAMETER      | TEST CONDITIONS  | MIN | TYP | MAX | UNIT |
|----------------|--|-----|-----|-----|------|
| Output current | $R_{(load)} = 3.3 \text{ k}\Omega, C_{(load)} = 10 \text{ pF}$ |     | 1   |     | mA   |
| Rise time      | $R_{(load)} = 3.3 \text{ k}\Omega, C_{(load)} = 10 \text{ pF}$ |     | 0.1 |     | μs   |



electrical characteristics over full range of operating conditions, (typical values are at PA\_VCC, PLL\_VCC, DDS\_VCC, DIG\_VCC, DEM\_VCC, MIX\_VCC, LNA\_VCC = 3 V,  $T_A$  = 25 °C) (unless otherwise noted) (continued)

## direct digital synthesizer (DDS)

| PARAMETER                                       | TEST CONDITIONS | MIN | TYP                   | MAX     | UNIT |       |
|---|-----------------|-----|-----------------------|---------|------|-------|
| Reference oscillator input frequency, $f_{ref}$ | as oscillator   |     | 15                    |         | 26   | MHz   |
| Reference oscillator input frequency, fref      | as buffer       |     | 15                    |         | 26   | IVITZ |
| Programmable DDS divider ratio                  | 22 bits         | 0   |                       | 4194303 |      |       |
| DDS divider resolution, $\Delta f$              |                 | N:  | $\times f$ ref $\div$ | 224     |      |       |
| FSK – modulation register ratio                 | 8 bits          | 0   |                       | 1020    |      |       |
| FSK – modulation resolution                     |                 | N:  | $\times f$ ref $\div$ | 222     |      |       |

## **PLL**

| PARAMETER                      | TEST CONDITIONS   | MIN | TYP                       | MAX | UNIT |
|--------------------------------|---|-----|---------------------------|-----|------|
| RF input frequency             |   | 850 |                           | 950 | MHz  |
| RF input power                 | Internal VCO by-passed; external input applied to VCO_TANK2   |     | -10                       |     | dBm  |
| RF input divider ratio, N      |   | 256 |                           | 512 |      |
| RF output frequency resolution |   | N×  | $f_{\text{ref}} \div 2^2$ | 24  |      |
| Charge pump current            | Programmable with external resistor, 100 kΩ nominal, APLL = 0 |     | 70                        |     | μΑ   |

## power amplifier

| PARAMETER                       | TEST CONDITIONS                         | MIN           | TYP  | MAX | UNIT   |
|---------------------------------|---|---------------|------|-----|--------|
| Frequency range                 |   | 850           |      | 950 | MHz    |
|                                 | 0 dB attenuation                        | -1            | 4.5  |     |        |
| A manife an australia a suran   | 10 dB attenuation                       | -5            | -0.5 |     | alD.aa |
| Amplifier output power          | 20 dB attenuation                       | -14           | -8   |     | dBm    |
|                                 | Amplifier off                           |               |      | -56 |        |
| Optimal load impedance          |   | See Figure 22 |      | 22  | Ω      |
| 2 <sup>nd</sup> -order harmonic | V <sub>CC</sub> = 3 V, 0 dB attenuation | -6            |      |     | dBc    |
| 3 <sup>rd</sup> -order harmonic | V <sub>CC</sub> = 3 V, 0 dB attenuation | -20           |      |     | dBc    |

## typical mode switching and lock times

| OPERATION   | OPERATION TEST CONDITIONS  |     | TYP | MAX | UNIT |
|---|--|-----|-----|-----|------|
| Frequency hop time between adjacent channels, during receive‡ | From transition of MODE to DATA_OUT valid, Channel spacing = 500 kHz, APLL = 111b (maximum)    | 30  |     | μs  |      |
| Receive-to-transmit turnaround time‡                          | From transition of MODE to valid RF signal at PA_OUT, PLL locked, 10.7 MHz RX to TX separation | 200 |     |     | μs   |
| Transmit-to-receive turnaround time‡                          | From transition of MODE to valid data at DATA_OUT, PLL locked, 10.7 MHz RX to TX separation    |     | 200 |     | μs   |
| Standby to receive time‡                                      | From rising edge of STDBY to valid data at DATA_OUT, APLL = 111b (maximum)                     |     | 600 |     | μs   |
| Standby to transmit time‡                                     | From rising edge of STDBY to valid RF signal at PA_OUT, APLL = 111b (maximum)                  |     | 500 |     | μs   |

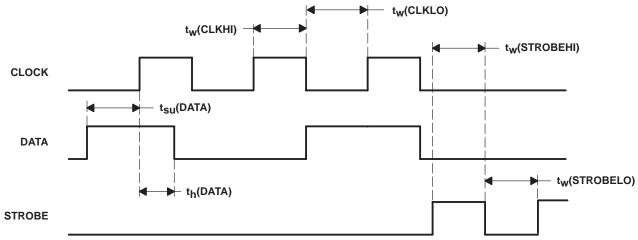
<sup>‡</sup> Highly dependent upon loop filter topology.



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# timing data for serial interface (see Figure 2)

|                       | PARAMETER  |    |    |     |  |  |  |
|-----------------------|--|----|----|-----|--|--|--|
| f(CLOCK)              | CLOCK frequency  |    | 20 | MHz |  |  |  |
| tw(CLKHI)             | CLOCK high time pulse width, CLOCK high                | 25 |    | ns  |  |  |  |
| tw(CLKLO)             | CLOCK low time pulse width, CLOCK low                  | 25 |    | ns  |  |  |  |
| t <sub>su(DATA)</sub> | Setup time, data valid before CLOCK high               | 25 |    | ns  |  |  |  |
| <sup>t</sup> h(DATA)  | Hold time, data valid after CLOCK high                 | 25 |    | ns  |  |  |  |
| tw(STROBEHI)          | Strobe high time pulse width, STROBE high (see note 2) | 25 |    | ns  |  |  |  |
| tw(STROBELO)          | Strobe low time pulse width, STROBE low                | 25 |    | ns  |  |  |  |



NOTE 2: CLOCK and DATA must both be low when STROBE is asserted (STROBE= 1).

Figure 2. Serial Data Interface Timing



## detailed description

## low-noise amplifier

The low-noise amplifier (LNA) provides a typical gain of 13 dB and a typical noise figure of 3.3 dB.

Two operating modes, normal and low-gain mode, can be selected. The normal operation mode is selected when maximum sensitivity at low input levels is required. If high RF input levels are applied to the TRF6900, the LNA should be operated in the low-gain mode. This ensures a minimum of nonlinear distortions in the overall receiver chain.

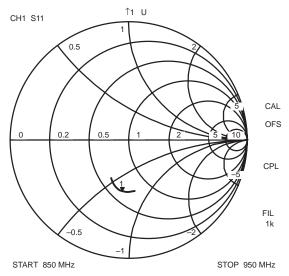


Figure 3. Typical LNA Input Impedance (S11) at Device Terminal LNA IN

Figure 4. Typical LNA Output Impedance (S22) at Device Terminal LNA\_OUT

The low impedance of the LNA input can be easily matched to 50  $\Omega$  to interface with a filter or an RF switch. At the LNA open collector output, a filter network can be used for image suppression as well as impedance matching.

#### RF mixer

The RF mixer is designed to operate with the on-chip VCO. If an external LO is used, a typical drive level of –10 dBm should be applied at the VCO input terminal. The mixer is a conventional double-balanced Gilbert cell mixer designed to provide a high IP3, typically 1 dBm.

Since the mixer output's push-pull amplifier has a 330  $\Omega$  output impedance, a conventional 330  $\Omega$  ceramic filter can be directly connected to the output without additional matching. The mixer output can also be directly connected to the 2<sup>nd</sup> IF amplifier/limiter input terminal, IF2\_IN, through a single conventional 330  $\Omega$  ceramic filter, thus bypassing the 1<sup>st</sup> IF amplifier.

Figure 5 and Figure 6 show the RF mixer input and output impedances, respectively.



#### RF mixer (continued)

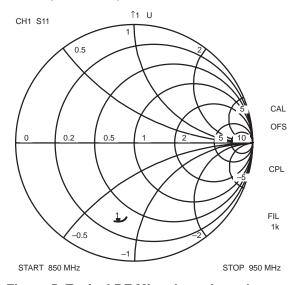


Figure 5. Typical RF Mixer Input Impedance (S11) at Device Terminal MIX\_IN

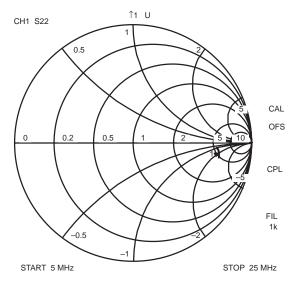


Figure 6. Typical RF Mixer Output Impedance (S22) at Device Terminal MIX OUT

### 1st IF amplifier

The 1st IF amplifier provides a typical gain of 7 dB to compensate for losses caused by a ceramic filter. The input and output of the 1st IF amplifier is matched internally to 330  $\Omega$ , permitting direct connections to 330  $\Omega$  ceramic filters. If filters with different impedances are used, an impedance matching network is required.

A second filter can be connected between the 1st IF amplifier and the  $2^{nd}$  IF amplifier/limiter to increase the receiver selectivity. Alternately, the RF mixer output can be directly connected to the  $2^{nd}$  IF amplifier as shown in Figure 7. A single ceramic filter can also be used to connect terminal 41 to terminal 39. In this case, a dc-blocking capacitor of 0.1  $\mu$ F should be used to connect terminal 44 to 42 to maximize receiver sensitivity.

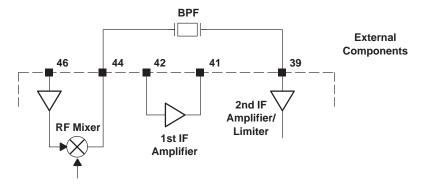


Figure 7. Bypassing the 1st IF Amplifier

Figure 8 and Figure 9 show the 1st IF amplifier input and output impedances, respectively.



# 1<sup>st</sup> IF amplifier (continued)

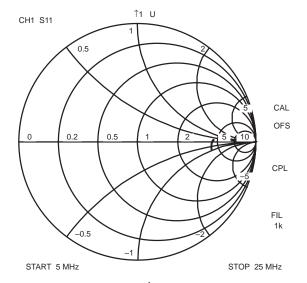


Figure 8. Typical 1<sup>st</sup> IF Amplifier Input Impedance (S11) at Device Terminal IF1\_IN

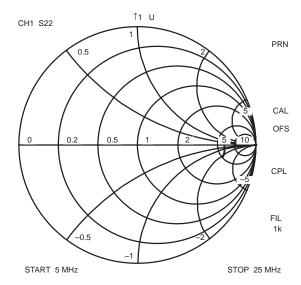


Figure 9. Typical 1<sup>st</sup> IF Amplifier Output Impedance (S22) at Device Terminal IF1\_OUT

## 2<sup>nd</sup> IF amplifier/limiter

The 2<sup>nd</sup> IF amplifier/limiter consists of several differential amplifier stages with an overall gain of approximately 80 dB. At the IF2\_IN 330  $\Omega$  input, a minimum signal level of approximately 32  $\mu$ V is required to generate a limited signal at the limiter output. The limiter output is directly fed to the FM/FSK demodulator.

Figure 10 shows the 2<sup>nd</sup> IF amplifier/limiter input impedance.

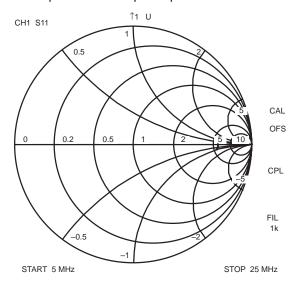


Figure 10. Typical 2<sup>nd</sup> IF Amplifier/Limiter Input Impedance (S11) at Device Terminal IF2\_IN



## TRF6900 SINGLE-CHIP RF TRANSCEIVER

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## received signal strength indicator (RSSI)

The received signal strength indicator provides a voltage at terminal 33, RSSI\_OUT, that is proportional to the RF limiter input level. The slope of the RSSI circuit is typically 19 mV/dB over a frequency range of 10 MHz to 21.4 MHz. Because of its ultrafast response time (typically 1 µs per –20 dBm to off step), the RSSI can easily be used as an amplitude-shift keying (ASK) or on/off keying (OOK) demodulator for data rates up to 100 kBit/sec.

#### FM/FSK demodulator

The demodulator is intended for analog (FM) and digital (FSK) frequency demodulation. It consists of a quadrature demodulator with an external LC tank circuit. A variable inductor, internal to the TRF6900, operates in parallel with the external tank circuit (see Figure 13), and is used to adjust the external tank circuit's resonant frequency. If the tolerances of the external demodulator tank circuit components can provide a maximum frequency error of less than 5%, then no additional adjustments are required. As long as the device is in the *learning mode*, the internal reactance automatically fine-adjusts the resonant frequency of the external LC tank circuit. Depending on the supply voltage, the tank circuit tuning range is approximately four times the discriminator 3-dB bandwidth.

While in the *learning mode i.e*, during a dc-free learning sequence of 0,1,0,1,0,...., the initial tolerances of the LC demodulator tank circuit are compensated and an external capacitor (connected to terminal 29, S&H\_CAP) is charged to a dc voltage that is proportional to the average demodulation dc level. This level establishes the decision threshold voltage and consequently sets the zero reference for the data slicer to generate the logical levels of the data sequence that follow the learning sequence. Therefore, the user can use a non-dc-free data signal.

The demodulator will be automatically activated if the limiter  $(x_LIM)$  and low-pass filter amplifier  $(x_LPF)$  are activated and the data switch is set to FSK/FM reception  $(x_SW = 0)$ .

#### data switch

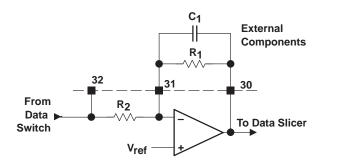
The TRF6900 incorporates an internal data switch used to select the input signal for the low-pass filter amplifier/post detection amplifier. Depending on the settings in the Mode0 or Mode1 enable registers (C-word, D-word), the user can select between OOK/ASK or FSK baseband processing without having to change external components.

### low-pass filter amplifier/post-detection amplifier

The low-pass filter amplifier/post-detection amplifier is configured to operate as a current-to-voltage amplifier and may be used to realize a low pass filter for post detection. The low-pass amplifier bandwidth may be adjusted according to noise and signal bandwidth requirements. An internal 10 pF capacitor sets the maximum –3 dB corner frequency to approximately 0.75 MHz (see Figures 11 and 12).



## low-pass filter amplifier/post-detection amplifier (continued)



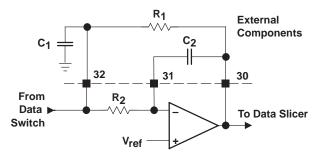


Figure 11. 1st-Order Low-Pass Filter Example

Figure 12. 2<sup>nd</sup>-Order Low-Pass Filter Example

The amplifier can be configured as a 1<sup>st</sup>- or 2<sup>nd</sup>-order low-pass filter with bandwidths that are determined by external components. The internal resistor R<sub>2</sub> is set to 10 k $\Omega$ , hence the –3dB corner frequency for a 2<sup>nd</sup>-order low pass filter (as shown in Figure 12) can be derived from the following formula:

$$f_{\rm g} \cong \frac{1}{2 \times \pi \times \sqrt{10 \text{ k}\Omega \times \text{R}_1 \times \text{C}_1 \times \text{C}_2}}$$

## data slicer

The data slicer is fundamentally a comparator. The data slicer provides binary logic level signals, derived from the demodulated and low pass-filtered IF signal, that are able to drive external CMOS compatible inputs. The noninverting input is directly connected to the internal reference voltage,  $V_{ref}$ , and the inverting input is driven by the output of the low-pass filter amplifier/post-detection amplifier. The decision threshold of the data slicer is determined by the internal reference voltage,  $V_{ref}$ . The automatic frequency control (AFC) loop scheme for the TRF6900 is shown in Figure 13.

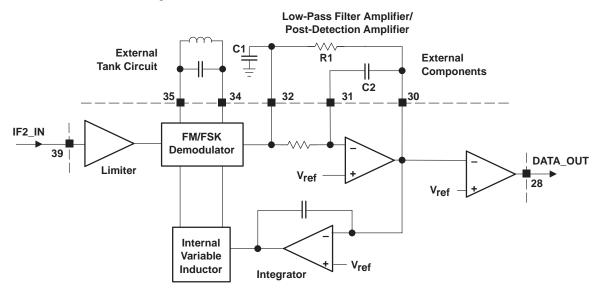


Figure 13. AFC Loop to Control the Data Slicer Decision Threshold



## data slicer (continued)

The integrator, acting as an error amplifier, takes the low-pass filtered output signal and generates a control voltage proportional to the frequency error of the external tank circuit as compared to the limiter output signal. By adjusting the value of the internal variable inductor, this control voltage is used to fine-tune the external tank to its nominal value.

The acquisition time of the AFC loop can be adjusted by an external capacitor connected to terminal 29, S&H\_CAP. This capacitor determines the integration time constant of the integrator *while in learning mode*. As a rule of thumb, the time constant of the AFC loop should be at least five times greater than the baseband signal fundamental period.

The time constant of the entire AFC control loop can be calculated as follows:

$$\tau_{AFC} \approx$$
 22 k $\Omega \times C_{terminal 29}$ 

The automatic frequency control loop controls the resonant frequency of the external LC tank without any additional external adjustments as long as *learning mode* operation is selected. If *hold mode* is selected, the AFC loop is open and an external dc voltage can be applied at terminal 29 to set the threshold of the data slicer. During *learning mode*, a precharged capacitor (connected to terminal 29, S&H\_CAP) can be used to set the dc threshold voltage of the data slicer in *hold mode*.

In other words, the data slicer constantly integrates the incoming signal during the learning sequence  $(0,1,0,1\ldots)$  and charges the external capacitor connected to terminal 29, S&H\_CAP to a dc voltage level,  $V_{ref}$ , that is proportional to the average demodulation dc level. After a predefined time (dependent upon the application), the data slicer is switched to *hold mode*. The data slicer stops integrating and uses the voltage stored on the external capacitor as the decision threshold between a logic 0 or a logic 1 on the DATA\_OUT terminal 28.

#### reference oscillator

The reference oscillator provides the DDS system clock. It allows operation, with a suitable external crystal, between 15 MHz and 26 MHz.

An external oscillator may be used to supply clock frequencies between 15 MHz and 26 MHz. The external oscillator should be directly connected to XOSC2, terminal 24. The other oscillator terminal (XOSC1, terminal 23) should be left open or can be used as a buffered version of the signal applied at terminal 24 (see Figure 14). The same crystal or externally supplied oscillator signal is used to derive both the transmit and receive frequencies.

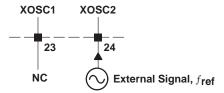


Figure 14. Applying an External Oscillator Signal



## direct digital synthesizer

## general principles of DDS operation

In general, a direct digital synthesizer (DDS) is based on the principle of generating a sinewave signal in the digital domain. Benefits include high precision, wide frequency range, a high degree of software programmability, and extremely fast lock times.

A block diagram of a typical DDS is shown in Figure 15. It generally consists of an accumulator, sine lookup table, a digital-to-analog converter, and a low-pass filter. All digital blocks are clocked by the reference oscillator.

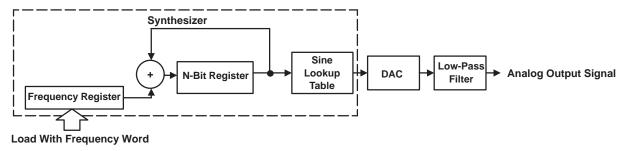


Figure 15. Typical DDS Block Diagram

The DDS constructs an analog sine waveform using an N-bit adder counting up from 0 to 2<sup>N</sup> in steps of the frequency register, whereby generating a digital ramp waveform. Each number in the N-bit output register is used to select the corresponding sine wave value out of the sine lookup table. After the digital-to-analog conversion, a low-pass filter is necessary to suppress unwanted spurious responses.

The analog output signal can be used as a reference input signal for a phase locked loop. The PLL circuit then multiplies the reference frequency by a predefined factor.

#### TRF6900 direct digital synthesizer implementation

A block diagram of the DDS implemented in the TRF6900 is shown in Figure 16. It consists of a 24-bit accumulator clocked by the reference oscillator along with control logic settings.

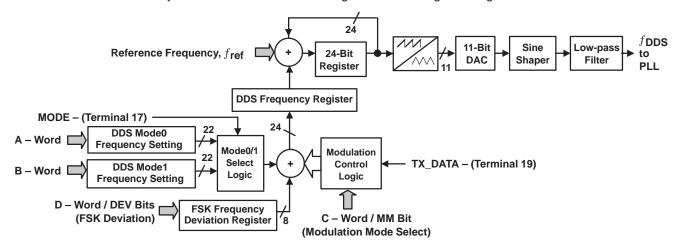


Figure 16. DDS Block Diagram as Implemented in the TRF6900



## TRF6900 direct digital synthesizer implementation (continued)

The frequency of the reference oscillator,  $f_{\text{ref}}$ , is the DDS sample frequency, which also determines the maximum DDS output frequency. Together with the accumulator width (in bits), the frequency resolution of the DDS can be calculated. Multiplied by the divider ratio (prescaler) of the PLL, N, the minimum frequency step size of the TRF6900 is calculated as follows:

$$\Delta f = N \times \frac{f_{\text{ref}}}{2^{24}}$$

The 24-bit accumulator can be programmed via two 22-bit frequency setting registers (the A-word determines the mode0 frequency, the B-word determines the mode1 frequency) with the two MSB bits set to zero. Consequently, the maximum bit weight of the DDS system is reduced to 1/8 (see Figure 17). This bit weight corresponds to a VCO output frequency of  $(f_{\text{ref}}/8) \times \text{N}$ . Depending on the MODE terminal's (terminal 17) logic level, the internal mode select logic loads the frequency register with either the DDS\_0 or DDS\_1 frequency (see Figure 16 and Figure 17).

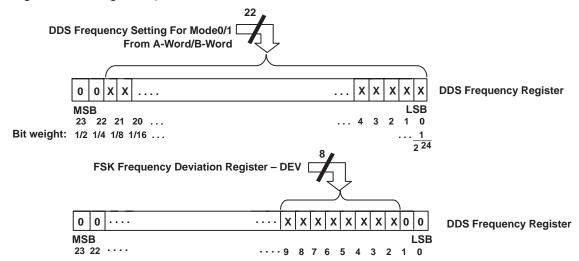


Figure 17. Implementation of the DDS Frequency and FSK Frequency Deviation in the DDS Frequency Register

The VCO output frequency,  $f_{\text{out}}$ , which is dependent on the DDS\_x frequency settings ( DDS\_0 in the A-word or DDS\_1 in the B-word ), can be calculated as follows:

$$f_{\text{out}} = \text{DDS}_x \times \text{N} \times \frac{f_{\text{ref}}}{2^{24}} = \text{N} \times \frac{f_{\text{ref}} \times \text{DDS}_x}{2^{24}}$$

If FSK modulation is selected (MM=0; C-Word, bit 16) the 8-bit FSK deviation register can be used to program the frequency deviation of the 2-FSK modulation. Figure 17 illustrates where the 8 bits of the FSK deviation register map into the 24-bit DDS frequency register. Since the two LSBs are set to zero, the total FSK deviation can be determined as follows:

$$\Delta f_{2\text{-FSK}} = \text{N} \times \frac{\text{DEV} \times f_{\text{ref}}}{2^{22}}$$

Hence, the 2-FSK frequency, set by the level of TX\_DATA, is calculated as follows:

$$f_{\text{out1:TX\_DATA} = \text{Low}} = \text{N} \times \frac{f_{\text{ref}} \times \text{DDS\_x}}{2^{24}} \qquad f_{\text{out2:TX\_DATA} = \text{High}} = \text{N} \times \frac{f_{\text{ref}} \times (\text{DDS\_x} + 4 \times \text{DEV})}{2^{24}}$$

This frequency modulated output signal is used as a reference input signal for the PLL circuit.



#### TRF6900 direct digital synthesizer implementation (continued)

Channel width (frequency deviation) for 2-FSK modulation and channel spacing are software programmable. The minimum channel width and minimum channel spacing depend on the RF system frequency plan.

Since the DDS registers are static, preprogrammed values are retained during standby mode. This feature greatly reduces turn on time, reduces current consumption when coming out of standby mode, and enables very fast lock-times. The PLL lock-times ultimately determine when data can be transmitted or received.

## phase-locked loop

The phase-locked loop (PLL) of the TRF6900 consists of a phase detector (PD) and a frequency acquisiton aid (FD), two charge pumps, an external loop filter, a voltage controlled oscillator (VCO), and a programmable fixed prescaler (N-divider) in the feedback loop (see Figure 18).

The PLL as implemented in the TRF6900 multiplies the DDS output frequency and further suppresses the unwanted spurious signals produced by the direct digital synthesizer.

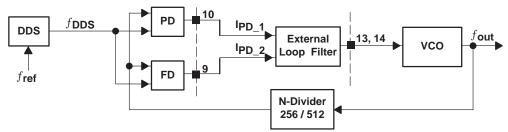


Figure 18. Basic PLL Structure

#### VCO

A modified Colpitts oscillator architecture with an external resonant circuit is used for the TRF6900. The internal bias current network adjusts the signal amplitude of the VCO. This allows a wide range of Q-factors (30....60) for the external tank circuit.

The VCO can be bypassed by applying an external RF signal at VCO\_TANK2, terminal 14. To drive the internal PLL and power amplifier, a typical level of -10 dBm should be applied. When an external VCO is used, the x\_VCO bit should be set to 0.

#### phase detector and charge pumps

The TRF6900 contains two charge pumps for locking to the desired frequency; one for coarse tuning of the frequency differences (called the frequency acquisition aid), and one for fine tuning of the phase differences (used in conjunction with the phase detector).

The XOR phase detector and charge pumps produce a mean output current that is proportional to the phase difference between the reference frequency and the VCO frequency divided by N; N=256 or 512. The TRF6900 generates the current pulses  $I_{PD\_1}$  during normal operation (PLL locked).

An additional slip detector and acquisition aid charge pump generates current pulses at terminal PD\_OUT2 during the lock-in of the PLL. This charge pump is turned off when the PLL locks in order to reduce current consumption. The multiplication factor of the acquisition aid current  $I_{PD_2}$  can be programmed by three bits (APLL) in the C-word.

The slip detector output, PD\_OUT2, at terminal 9 should be connected directly to the loop filter capacitor  $C_1$ , as in Figure 21. The nominal charge pump current  $I_0$  is determined by the external resistor  $R_{PD}$ , connected to terminal 8, and can be calculated as follows:

$$I_0 = \frac{7 \text{ V}}{R_{PD}}$$



## phase detector and charge pumps (continued)

During normal operation (PLL locked), the acquisition aid charge pump is disabled and the maximum charge pump current I<sub>PD 1</sub> is determined by the nominal value I<sub>0</sub> (see Figure 19).



Figure 19. Normal Operation Charge Pump Current, IPD 1

Each time the PLL is in an unlocked condition, the acquisition aid charge pump generates current pulses  $I_{PD_2}$ . The  $I_{PD_2}$  current pulses are APLL times larger than  $I_0$  (see Figure 20).

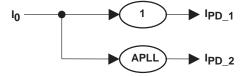


Figure 20. Acquisition Aid, I<sub>PD 2</sub>, and Normal Operation, I<sub>PD 1</sub>, Charge Pump Currents

### programmable divider

The internal divider ratio, N, can be set to 256 or 512 via the C-word. Since a higher divider ratio adds additional noise within the multiplication loop, the lowest divider ratio possible for the target application should be used.

## loop filter

Loop filter designs are a balance between lock-time, noise, and spurious suppression. For the TRF6900, common loop filter design rules can be used to determine an appropriate low-pass filter. Standard formulas can be used as a first approach to calculate a basic loop filter. Figure 21 illustrates a basic 3<sup>rd</sup>-order loop filter.

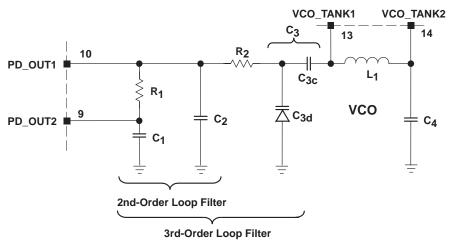


Figure 21. Basic 3<sup>rd</sup>-Order Loop Filter Structure

For maximum suppression of the unwanted frequency components, the loop filter bandwidth should generally be made as narrow as possible. At the same time, the filter bandwidth has to be wide enough to allow for the 2-FSK modulation and appropriate lock-time. A detailed simulation of the phase-locked loop should be performed and later verified on PCB implementations.



## power amplifier

The power amplifier (PA) can be programmed via two bits (P0 and P1 in the D-word) to provide varying output power levels. Several control loops are implemented internally to set the output power and to minimize the sensitivity of the power amplifier to temperature, load impedance, and power supply variations. The output stage of the PA usually operates in Class-C and enables easy impedance matching. PA\_OUT, terminal 5, is an open collector output terminal.

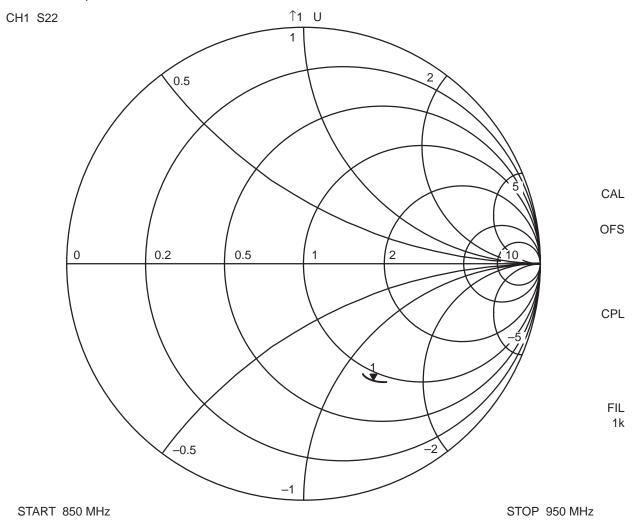


Figure 22. Power Amplifier Output Impedance (S22) at Device Terminal 5



#### serial control interface

A 3-wire unidirectional serial bus (CLOCK, DATA, STROBE) is used to program the TRF6900 (see Figure 23). The internal registers contain all user programmable variables including the DDS frequency setting registers as well as all control registers.

At each rising edge of the CLOCK signal, the logic value on the DATA terminal is written into a 24-bit shift register. Setting the STROBE terminal high loads the programmed information into the selected latch. While the STROBE signal is high, the DATA and CLOCK lines must be low (see Figure 2). Since the CLOCK and STROBE signals are asynchronous, care should be taken to ensure these signals remain free of glitches and noise.

As additional leading bits are ignored, only the least significant 24 bits are serial-clocked into the shift register. Due to the static CMOS design, the serial interface consumes virtually no current and it can be programmed in active as well as in standby mode.

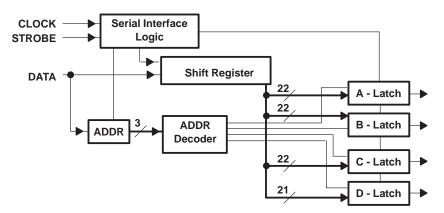


Figure 23. Serial Interface Block Diagram

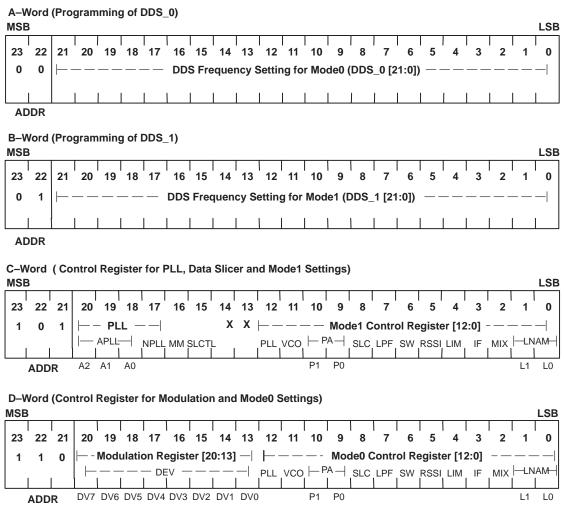
The control words are 24 bits in length. The first incoming bit functions as the most significant bit (MSB).

To fully program the TRF6900, four 24-bit words must be sent: the A-, B-, C-, and D-word. If individual bits within a word are to be changed, then it is sufficient to program only the appropriate 24-bit word.

The definition of the control words are illustrated in Figure 24. Tables 1, 2, and 3 describe the function of each parameter.

An ADDR equal to 111 is reserved for test purposes and should not be used.





NOTE: Start programming with MSB and ensure that the CLOCK and DATA lines are low during the rising edge of the strobe signal.

Figure 24. Serial Control Word Format



Table 1. Mode0 Control Register Description (D-Word)

| SYMBOL  | BIT      | NUMBER  | DESCRIPTION  | INITIAL SETTINGS AFTER POWER-UP |                  |
|---------|----------|---------|--|---------------------------------|------------------|
| STWIBOL | LOCATION | OF BITS | DESCRIPTION  | DEFAULT<br>STATE                | DEFAULT<br>VALUE |
| 0_LNAM  | [1:0]    | 2       | Low-noise amplifier operation mode  L1 L0  0 0 : LNA disabled  0 1 : LNA enable – low-gain mode  1 0 : LNA disabled  1 1 : LNA enable – normal operation mode  | Disabled                        | 00b              |
| 0_MIX   | [2]      | 1       | Enable mixer 1: enabled 0: disabled  | Disabled                        | 0b               |
| 0_IF    | [3]      | 1       | Enable 1 <sup>st</sup> IF amplifier 1: enabled 0: disabled   | Disabled                        | 0b               |
| 0_LIM   | [4]      | 1       | Enable limiter 1: enabled 0: disabled  | Disabled                        | 0b               |
| 0_RSSI  | [5]      | 1       | Enable RSSI 1: enabled 0: disabled   | Disabled                        | 0b               |
| 0_SW    | [6]      | 1       | Data switch  0 : LPF amplifier input routed to demodulator (FSK/FM)  1 : LPF amplifier input routed to RSSI (OOK/ASK)  | Routed to<br>Demodulator        | 0b               |
| 0_LPF   | [7]      | 1       | Enable LPF amplifier 1: enabled 0: disabled  | Disabled                        | 0b               |
| 0_SLC   | [8]      | 1       | Enable data slicer 1: enabled 0: disabled  | Disabled                        | 0b               |
| 0_PA    | [10:9]   | 2       | Power amplifier mode  P1 P0  0 0 : disabled  0 1 : 10 dB attenuation, enable modulation via TX_DATA  1 0 : 20 dB attenuation, enable modulation via TX_DATA  1 : 0 dB attenuation, enable modulation via TX_DATA | Disabled                        | 00b              |
| 0_VCO   | [11]     | 1       | During operation, this bit should always be enabled (1: enabled), unless an external VCO is used.  | Disabled                        | 0b               |
| 0_PLL   | [12]     | 1       | Enable PLL (DDS system, RF, VCO, divider, phase comparator and charge pump)  1: enabled  0: disabled   | Disabled                        | 0b               |

NOTE: The FM/FSK demodulator is automatically enabled if the limiter and low-pass amplifier are enabled and the data switch is set to FSK reception.



Table 2. Mode1 Control Register Description (C-Word)

| SYMBOL | BIT      | NUMBER  | DESCRIPTION  | INITIAL SE<br>AFTER PO   |                  |
|--------|----------|---------|--|--------------------------|------------------|
| STWBOL | LOCATION | OF BITS | DESCRIPTION  | DEFAULT<br>STATE         | DEFAULT<br>VALUE |
| 1_LNAM | [1:0]    | 2       | Low-noise amplifier operation mode  L1 L0  0 0 : LNA disabled  0 1 : LNA enable – low-gain mode  1 0 : LNA disabled  1 1 : LNA enable – normal operation mode  | Disabled                 | 00b              |
| 1_MIX  | [2]      | 1       | Enable mixer 1: enabled 0: disabled  | Disabled                 | 0b               |
| 1_IF   | [3]      | 1       | Enable 1 <sup>st</sup> IF amplifier 1: enabled 0: disabled   | Disabled                 | 0b               |
| 1_LIM  | [4]      | 1       | Enable limiter 1: enabled 0: disabled  | Disabled                 | 0b               |
| 1_RSSI | [5]      | 1       | Enable RSSI 1: enabled 0: disabled   | Disabled                 | 0b               |
| 1_SW   | [6]      | 1       | Data switch  0 : LPF amplifier input routed to demodulator (FSK/FM)  1 : LPF amplifier input routed to RSSI (OOK/ASK)  | Routed to<br>Demodulator | 0b               |
| 1 LPF  | [7]      | 1       | Enable LPF amplifier 1: enabled 0: disabled  | Disabled                 | 0b               |
| 1_SLC  | [8]      | 1       | Enable data slicer 1: enabled 0: disabled  | Disabled                 | 0b               |
| 1_PA   | [10:9]   | 2       | Power amplifier mode  P1 P0 0 0 : disabled 0 1 : 10 dB attenuation, enable modulation via TX_DATA 1 0 : 20 dB attenuation, enable modulation via TX_DATA 1 : 0 dB attenuation, enable modulation via TX_DATA | Disabled                 | 00b              |
| 1_VCO  | [11]     | 1       | During operation, this bit should always be enabled (1: enabled), unless an external VCO is used.  | Disabled                 | 0b               |
| 1_PLL  | [12]     | 1       | Enable PLL (DDS system, VCO, RF divider, phase comparator and charge pump)  1: enabled  0: disabled  | Disabled                 | 0b               |

NOTE: The FM/FSK demodulator is automatically enabled if the limiter and low-pass amplifier are enabled and the data switch is set to FSK reception.



**Table 3. Miscellaneous Control Register Description** 

| SYMBOL  | WORD   | BIT      | NUMBER  | DESCRIPTION   |                  | ETTINGS<br>OWER-UP |
|---------|--------|----------|---------|---|------------------|--------------------|
| STWIBOL | WORD   | LOCATION | OF BITS | DESCRIPTION   | DEFAULT<br>STATE | DEFAULT<br>VALUE   |
| DDS_0   | A-word | [21:0]   | 22      | DDS frequency setting in Mode0  | Zero             | All zeroes         |
| DDS_1   | B-word | [21:0]   | 22      | DDS frequency setting in Mode1  | Zero             | All zeroes         |
| DEV     | D-word | [20:13]  | 8       | FSK frequency deviation register  | Zero             | All zeroes         |
| SLCTL   | C-word | [15]     | 1       | Slicer mode select bit 0 : hold mode 1 : learning mode  | Hold<br>mode     | 0b                 |
| APLL    | C-word | [20:18]  | 3       | Acceleration factor for the frequency acquisition aid charge pump    A2                                 | Zero             | 000b               |
| NPLL    | C-word | [17]     | 1       | PLL divider ratio 0: 256 1: 512   | 256              | 0b                 |
| ММ      | C-word | [16]     | 1       | Modulation mode select. Sets the behavior of pin TX_DATA to FSK data input.  0 : FSK/FM  1 : Do not use | FSK<br>mode      | 0b                 |

## operating modes

Tables 4 and 5 illustrate operating modes and transmit frequencies as set by the STDBY, MODE, and TX\_DATA terminals used in conjunction with the DDS frequency settings.

Table 4. Transmitting Data in FSK Mode (MM bit set to 0)

|       | TERMINAL | -       | TRANSMIT FREQUENCY  |  |  |
|-------|----------|---------|---|--|--|
| STDBY | MODE     | TX_DATA | TRANSMIT FREQUENCY  |  |  |
| 1     | 0        | 0       | $f_{\text{out}} = f_{\text{ref}} \times N \times (\text{DDS}_0)/2^{24}$                       |  |  |
| 1     | 0        | 1       | $f_{\text{out}} = f_{\text{ref}} \times N \times (DDS_0 + 4 \times DEV)/2^{24}$               |  |  |
| 1     | 1        | 0       | $f_{\text{out}} = f_{\text{ref}} \times N \times (DDS_1)/2^{24}$                              |  |  |
| 1     | 1        | 1       | $f_{\text{out}} = f_{\text{ref}} \times N \times (\text{DDS}_1 + 4 \times \text{dev})/2^{24}$ |  |  |

**Table 5. Operating Mode Per STDBY Terminal** 

| STDBY | OPERATING MODE                                      |  |  |  |
|-------|---|--|--|--|
| 0     | Standby/programming mode – power down of all blocks |  |  |  |
| 1     | Operating mode and programming mode                 |  |  |  |

Two independent operating modes, Mode0 and Mode1, allow extremely fast switching between two preprogrammed settings by toggling the MODE terminal. Each mode can be viewed as a bank of configuration registers which store the frequency settings and the enable/disable settings for each functional block of the TRF6900. The MODE terminal is then used to asynchronously switch between Mode0 and Mode1 as shown in Figure 25. Several examples of operating sequences are shown in Table 6.



## operating modes (continued)

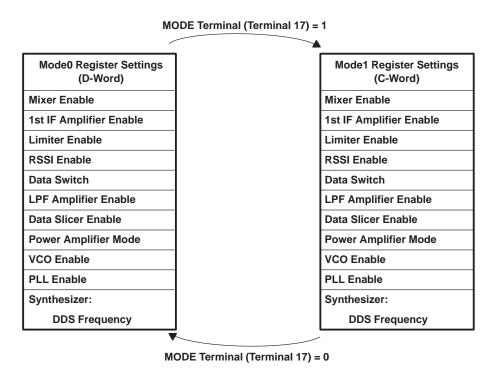


Figure 25. Interaction Between MODE Terminal and Preprogrammed Mode0 and Mode1 Control Registers

**Table 6. Operating Mode Examples** 

| FUNCTION/DESCRIPTION  | MODE0                                       | MODE1                                   |
|---|---|---|
| Receive polling with frequency hopping, or scan band                      | Receive on frequency 0                      | Receive on frequency 1                  |
| Transmit and receive on different frequencies                             | Transmit on frequency 0                     | Receive on frequency 1                  |
| Broadcast on one frequency and receive on another                         | Transmit on frequency 0 (broadcast channel) | Receive on frequency 1                  |
| Rapid switch between receive and power saving mode (keep DDS/VCO running) | Receive on frequency 0                      | All blocks off except DDS, VCO, and PLL |
| Emulate FSK transmit operation using the MODE terminal for wideband FSK   | Transmit on frequency 0                     | Transmit on frequency 0 + deviation     |

## operating modes (continued)

Figure 26 illustrates how the user of the TRF6900 can preload the serial control words while in standby/programming mode and then receive baseband data while in operating mode.

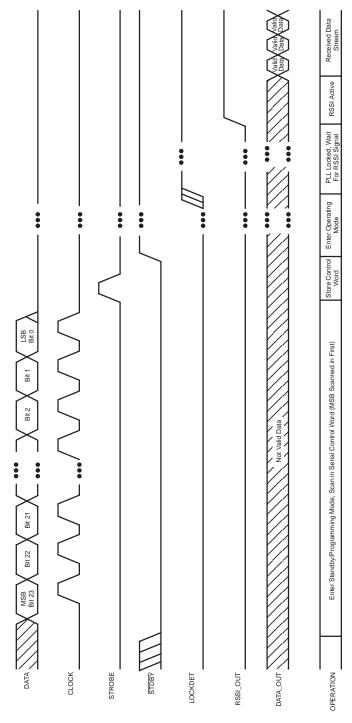


Figure 26. Preloading Serial Control Word and Receiving Baseband Data



### **APPLICATION INFORMATION**

A typical application schematic for an FSK system operating in the European 868 MHz to 870 MHz ISM band is shown in Figure 27.

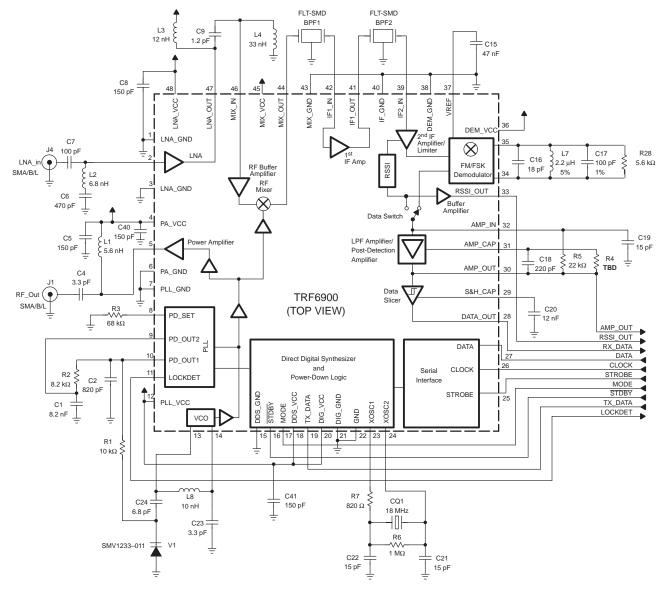


Figure 27. Typical Application Schematic for 868 to 870 MHz European ISM Band



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## **APPLICATION INFORMATION**

# external component list (5% tolerance unless otherwise noted) for Figure 27

| DESIGNATOR | DESCRIPTION (SIZE) | VALUE       | MANUFACTURER            | PART NUMBER/COMMENTS              |
|------------|--------------------|-------------|-------------------------|-----------------------------------|
| C1         | Capacitor          | 8.2 nF      |                         |                                   |
| C2         | Capacitor          | 820 pF      |                         |                                   |
| C4         | Capacitor          | 3.3 pF      |                         |                                   |
| C5         | Capacitor          | 150 pF      |                         |                                   |
| C6         | Capacitor          | 470 nF      |                         |                                   |
| C7         | Capacitor          | 100 pF      |                         |                                   |
| C8         | Capacitor          | 150 pF      |                         |                                   |
| C9         | Capacitor          | 1.2 pF      |                         |                                   |
| C15        | Capacitor          | 47 nF       |                         |                                   |
| C16        | Capacitor          | 18 nF       |                         |                                   |
| C17        | Capacitor          | 100 pF      |                         | 1% tolerance                      |
| C18        | Capacitor          | 220 pF      |                         |                                   |
| C19        | Capacitor          | 15 pF       |                         |                                   |
| C20        | Capacitor          | 12 nF       |                         |                                   |
| C21        | Capacitor          | 15 pF       |                         |                                   |
| C22        | Capacitor          | 15 pF       |                         |                                   |
| C23        | Capacitor          | 3.3 pF      |                         |                                   |
| C24        | Capacitor          | 6.8 pF      |                         |                                   |
| C40        | Capacitor          | 150 pF      |                         |                                   |
| C41        | Capacitor          | 150 pF      |                         |                                   |
| L1         | Coil               | 5.6 nH      | Murata                  | LQW1608                           |
| L2         | Coil               | 6.8 nH      | Murata                  | LQW1608                           |
| L3         | Coil               | 12 nH       | Murata                  | LQW1608                           |
| L4         | Coil               | 33 nH       | Murata                  | LQW1608                           |
| L7         | Coil               | 2.2 μΗ      | Murata                  | LQH1N2RZJ04, 5% tolerance         |
| L8         | Coil               | 10 nH       | Murata                  | LQW1608, 5% tolerance             |
| R1         | Resistor           | 10 kΩ       |                         |                                   |
| R2         | Resistor           | 8.2 kΩ      |                         |                                   |
| R3         | Resistor           | 68 kΩ       |                         |                                   |
| R4         | Resistor           | Optional    |                         |                                   |
| R5         | Resistor           | 22 kΩ       |                         |                                   |
| R6         | Resistor           | 1 ΜΩ        |                         |                                   |
| R7         | Resistor           | 820 Ω       |                         |                                   |
| R28        | Resistor           | 5.6 kΩ      |                         |                                   |
| V1         | Varactor diode     | SMV1233-011 | Alpha Industries        |                                   |
| CQ1        | Crystal            | 18 MHz      | CMAC Frequency Products | CX-1 SMI                          |
| BPF1       | Filter             |             | Murata                  | SFECV10.7MJ-Z, 10.7 MHz IF filter |
| BPF2       | Filter             |             | Murata                  | SFECV10.7MJ-Z, 10.7 MHz IF filter |



### **APPLICATION INFORMATION**

A typical application schematic for an FSK system operating in the North American 902 MHz to 928 MHz ISM band is shown in Figure 28.

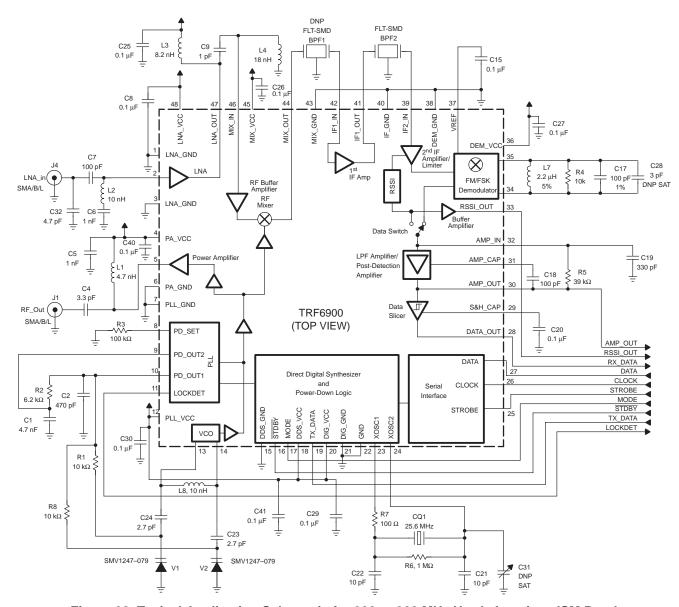


Figure 28. Typical Application Schematic for 902 to 928 MHz North American ISM Band

## external component list (5% tolerance unless otherwise noted) for Figure 28

| DESIGNATOR | DESCRIPTION (SIZE) | VALUE  | MANUFACTURER | PART NUMBER/COMMENTS |
|------------|--------------------|--------|--------------|----------------------|
| C1         | Capacitor          | 4.7 nF |              |                      |
| C2         | Capacitor          | 470 pF |              |                      |
| C3         | Capacitor          | 0.5 pF |              |                      |
| C4         | Capacitor          | 3.3 pF |              |                      |



## **APPLICATION INFORMATION**

# external component list (5% tolerance unless otherwise noted) for Figure 28 (continued)

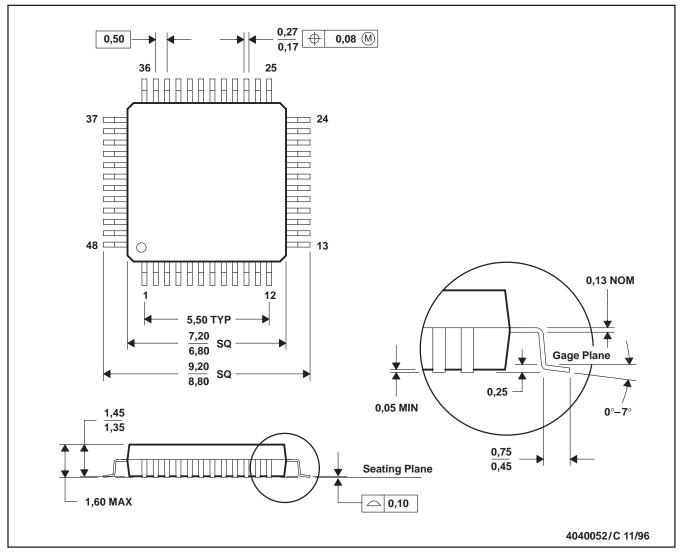
| DESIGNATOR | DESCRIPTION (SIZE) | VALUE       | MANUFACTURER  | PART NUMBER/COMMENTS   |
|------------|--------------------|-------------|---|--|
| C5         | Capacitor          | 1 nF        |   |  |
| C6         | Capacitor          | 1 nF        |   |  |
| C7         | Capacitor          | 100 pF      |   |  |
| C8         | Capacitor          | 0.1 μF      |   |  |
| C9         | Capacitor          | 1 pF        |   |  |
| C15        | Capacitor          | 0.1 μF      |   |  |
| C17        | Capacitor          | 100 pF      |   | 1% tolerance   |
| C18        | Capacitor          | 100 pF      |   |  |
| C19        | Capacitor          | 330 pF      |   |  |
| C20        | Capacitor          | 0.1 μF      |   |  |
| C21        | Capacitor          | 10 pF       |   |  |
| C22        | Capacitor          | 10 pF       |   |  |
| C23        | Capacitor          | 2.7 pF      |   |  |
| C24        | Capacitor          | 2.7 pF      |   |  |
| C25        | Capacitor          | 0.1 μF      |   |  |
| C26        | Capacitor          | 0.1 μF      |   |  |
| C27        | Capacitor          | 0.1 μF      |   |  |
| C28        | Capacitor          | 3 pF        |   | Select at test (SAT), Do not place (DNP)   |
| C29        | Capacitor          | 0.1 μF      |   |  |
| C30        | Capacitor          | 0.1 μF      |   |  |
| C31        | Capacitor          |             |   | Select at test (SAT), Do not place (DNP)   |
| C32        | Capacitor          | 4.7 pF      |   |  |
| C40        | Capacitor          | 0.1 μF      |   |  |
| C41        | Capacitor          | 150 pF      |   |  |
| L1         | Coil               | 4.7 nH      | Murata  | LQW1608  |
| L2         | Coil               | 10 nH       | Murata  | LQW1608  |
| L3         | Coil               | 8.2 nH      | Murata  | LQW1608  |
| L4         | Coil               | 18 nH       | Murata  | LQW1608  |
| L7         | Coil               | 2.2 μΗ      | Murata  | LQH1N2RZJ04, 5% tolerance  |
| L8         | Coil               | 10 nH       | Murata  | LQW1608, 5% tolerance  |
| R1         | Resistor           | 10 kΩ       |   |  |
| R2         | Resistor           | 6.2 kΩ      |   |  |
| R3         | Resistor           | 100 kΩ      |   |  |
| R4         | Resistor           | 10 kΩ       |   |  |
| R5         | Resistor           | 39 kΩ       |   |  |
| R6         | Resistor           | 1 ΜΩ        |   |  |
| R7         | Resistor           | 100 Ω       |   |  |
| R8         | Resistor           | 10 kΩ       |   |  |
| V1, V2     | Varactor diode     | SMV1247-079 | Alpha Industries  |  |
| CQ1        | Crystal            | 25.6 MHz    | ICM (International Crystal Manufacturing, Incorporated) | 865842   |
| BPF1       | Filter             |             | Murata  | SFECV10.7H-A, 10.7 MHz IF filter, DNP. not used, replace with 0.1 $\mu$ F capacitor. |
| BPF2       | Filter             |             | Murata  | SFECV10.7H-A, 10.7 MHz IF filter   |



### **MECHANICAL DATA**

## PT (S-PQFP-G48)

## **PLASTIC QUAD FLATPACK**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-026
- D. This may also be a thermally enhanced plastic package with leads connected to the die pads.



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